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U.S. Patent OFFICE OF COMMERCE

U.S. Patent OFFICE OFFIC Application Number Substitute for form 1449/PTO 09-17-2003 Fillng Date INFORMATION DISCLOSURE SHI ET AL First Named Inventor 2873 STATEMENT BY APPLICANT Art Unit Thomas P120-US Examiner Name (Use as many sheets as necessary) Attorney Docket Number of 1

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1	A2	US- 6,162,367 US- 6,197,610 B1	03/06/2001	TODA	
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					Date	9/2/05	

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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6 of Sheet

Co	mplete if Known
Application Number	10/666,002
Filing Date	9/17/03
First Named Inventor	Shi
Art Unit	Not Yel Assigned 2873
Examiner Name	Not Yet Assigned Thomas
Attorney Docket Number	P120-US

		U.S. PATI	ENT DOCUMENTS	
Examiner Initials	Cite No. 1 Number - Kind Code ² (If known	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
BN7	US- 3,511,727	05-12-1970	Hays, R.G.	
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Examiner Initials	Cite No. ¹	Foreign Patent Document Country Code 3 "Number 4" - Kind Code 4" (If known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Т6
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BUT		WO-98/32163	07-23-1998	Tai et al.		

Thomas Date Examiner Considered Signature

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Co	mplete if Known
Application Number	10/666,002
Filing Date	9/17/03
First Named Inventor	Shi
Art Unit	Not Yor Assigned 2873
Examiner Name	Not Yel Asstaned Thomas
Attorney Docket Number	P120-US

	 	U.S. PAT	ENT DOCUMENTS	
Examiner Initials	 Document Number Number - Kind Code ² (if known	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Pessages or Relevant Figures Appear
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Examiner Initials	Cite No.1	Foreign Patent Document Country Code 3 - Number 4 - Kind Code 3 (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Т6
WI		JP-1997/09251981-A	09-22-1997	Kazuaki et al.		
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BNI		JP-1986/61181131-A	08-13-1986	Shinii et al.		

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Art Unit	Not Yet Assigned 2873
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BNT		JP-1989/01208834-A	08-22-1989	Nobuo et al.		
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		JP-1992/04096222-A	03-27-1992	Atsuyuki, A.		
BM		JP-1995/07029823-A	01-31-1995	Hiroshi, T.		
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10/666,002 **Application Number** 9/17/03 Filing Date Shi First Named Inventor Not Yet Assigned **Group Art Unit** Not Yet Assigned Examiner Name Attorney Docket Number P120-US

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		OTHER PRIOR ART NON PATENT LITERATURE DOCUMENTS	_
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-Issue number(s), publisher_city and/or country where published.	1
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Signature	Isandi Framas	Considered	110103



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Application Number	10/666,002				
Filing Date	9/17/03				
First Named Inventor	Shi				
Group Art Unit .	Not Yet Assigned 12873				
Examiner Name	Not Yel Assigned Thomas				
Attorney Docket Number	P120-US				

		OTHER PRIOR ART NON PATENT LITERATURE DOCUMENTS	
Examiner Initials	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-Issue number(s), publisher, city and/or country where published	T:
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Complete if Known Substitute for form 14498/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date Shi STATEMENT BY APPLICANT First Named Inventor Not Yet Assigned Group Art Unit Not Yet Assigned (use as many sheets as necessary) **Examiner Name** Attorney Docket Number P120-US Sheet of

Examiner Initials	Cite No. 1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T
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Complete if Known Substitute for form 1449A/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date STATEMENT BY APPLICANT **First Named Inventor** Shi Art Unit Not Yet Assigned (use as many sheets as necessary) Not-Yet Assigned namas **Examiner Name** of 6 Attorney Docket Number P120-US Sheet

			U.S. PAT	ENT DOCUMENTS	
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l	Signature Sundy Shows	Considered 7/0/03

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		OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS						
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